

## EAST Search History

| Ref # | Hits | Search Query   | DBs                               | Default Operator | Plurals | Time Stamp       |
|-------|------|--|-----------------------------------|------------------|---------|------------------|
| L17   | 0    | electrodeplating adj process and pcb                     | USPAT; EPO; JPO; DERWENT; IBM_TDB | OR               | ON      | 2008/10/09 15:55 |
| L18   | 2    | electrodeplating adj process                             | USPAT; EPO; JPO; DERWENT; IBM_TDB | OR               | ON      | 2008/10/09 15:55 |
| L19   | 0    | electrodless adj plating adj process                     | USPAT; EPO; JPO; DERWENT; IBM_TDB | OR               | ON      | 2008/10/09 15:56 |
| L20   | 7059 | electroplating adj process                               | USPAT; EPO; JPO; DERWENT; IBM_TDB | OR               | ON      | 2008/10/09 15:56 |
| L21   | 4    | electroplating adj process near pcb                      | USPAT; EPO; JPO; DERWENT; IBM_TDB | OR               | ON      | 2008/10/09 15:56 |
| L22   | 2    | electrodeplating adj process                             | USPAT; EPO; JPO; DERWENT; IBM_TDB | OR               | ON      | 2008/10/09 15:57 |
| L23   | 0    | electrodplating adj process                              | USPAT; EPO; JPO; DERWENT; IBM_TDB | OR               | ON      | 2008/10/09 15:57 |
| L24   | 7059 | electroplating adj process                               | USPAT; EPO; JPO; DERWENT; IBM_TDB | OR               | ON      | 2008/10/09 15:57 |
| L25   | 56   | electroplating adj process and pcb and anode and cathode | USPAT; EPO; JPO; DERWENT; IBM_TDB | OR               | ON      | 2008/10/09 15:57 |
| L26   | 97   | electroplating adj process and constant adj voltage      | USPAT; EPO; JPO; DERWENT; IBM_TDB | OR               | ON      | 2008/10/09 16:42 |

|     |    |   |   |    |    |                     |
|-----|----|---|---|----|----|---------------------|
| L27 | 27 | ("2733198"  <br>"2842488"  <br>"2882209"  <br>"2972572"  <br>"3956120"  <br>"4092226"  <br>"4272335"  <br>"4461680"  <br>"4555315"  <br>"4563399"  <br>"5232575"  <br>"5252196"  <br>"5618634"  <br>"5935762"  <br>"5936707"  <br>"5939788"  <br>"5972192"  <br>"6074544"  <br>"6099711"  <br>"6113771"  <br>"6132584"  <br>"6197181"  <br>"6224737").PN. | US-PGPUB;<br>USPAT; USOCR   | OR | ON | 2008/10/09<br>16:51 |
| L28 | 10 | electroplating adj<br>process and constant<br>adj voltage and<br>interruption   | USPAT; EPO;<br>JPO;<br>DERWENT;<br>IBM_TDB                              | OR | ON | 2008/10/09<br>16:55 |
| L29 | 1  | electroplating adj<br>process and voltage<br>adj time near<br>interruption  | USPAT; EPO;<br>JPO;<br>DERWENT;<br>IBM_TDB                              | OR | ON | 2008/10/09<br>16:57 |
| L30 | 3  | electroplating adj<br>process and voltage<br>adj time near<br>interruption  | US-PGPUB;<br>USPAT;<br>USOCR; FPRS;<br>EPO; JPO;<br>DERWENT;<br>IBM_TDB | OR | ON | 2008/10/09<br>16:57 |
| L31 | 3  | electroplating and<br>voltage adj time near<br>interruption   | US-PGPUB;<br>USPAT;<br>USOCR; FPRS;<br>EPO; JPO;<br>DERWENT;<br>IBM_TDB | OR | ON | 2008/10/09<br>16:58 |
| L32 | 3  | plating and voltage<br>adj time near<br>interruption  | US-PGPUB;<br>USPAT;<br>USOCR; FPRS;<br>EPO; JPO;<br>DERWENT;<br>IBM_TDB | OR | ON | 2008/10/09<br>16:59 |

|     |    |                                       |   |    |    |                     |
|-----|----|---------------------------------------|---|----|----|---------------------|
| L33 | 19 | voltage adj time near<br>interruption | US-PGPUB;<br>USPAT;<br>USOCR; FPRS;<br>EPO; JPO;<br>DERWENT;<br>IBM_TDB | OR | ON | 2008/10/09<br>16:59 |
|-----|----|---------------------------------------|---|----|----|---------------------|

10/9/08 5:00:01 PM

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